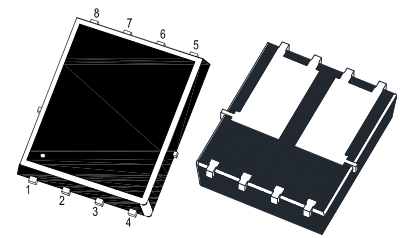
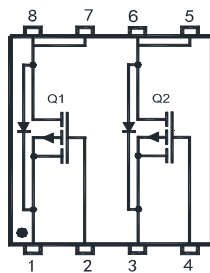


WTM603B600LS-HAF

Dual P-Channel Enhancement Mode MOSFET

Features

- Halogen and Antimony Free(HAF),
RoHS compliant



1.Source1 2.Gate1 3.Source2 4.Gate2
5.Drain2 6.Drain2 7.Drain1 8.Drain1
DFN5060 Plastic Package

Key Parameters (Q1/Q2)

Parameter	Value	Unit
$-BV_{DSS}$	30	V
$R_{DS(ON)}$ Max	60 @ $-V_{GS} = 10$ V	m Ω
	110 @ $-V_{GS} = 4.5$ V	
$-V_{GS(th)}$ typ	1.6	V
Q_g typ	9 @ $-V_{GS} = 10$ V	nC

Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified) (Q1/Q2)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	$-V_{DS}$	30	V	
Gate-Source Voltage	V_{GS}	± 20	V	
Drain Current	$-I_D$	$T_c = 25^\circ\text{C}$	17	A
		$T_c = 100^\circ\text{C}$	10	A
Peak Drain Current ¹⁾	$-I_{DM}$	40	A	
Avalanche Current	$-I_{AS}$	12	A	
Avalanche Energy ²⁾	E_{AS}	7	mJ	
Power Dissipation	P_D	25	W	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$	

Thermal Characteristics (Q1/Q2)

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	5	$^\circ\text{C}/\text{W}$
Thermal Resistance from Junction to Ambient ³⁾	$R_{\theta JA}$	95	$^\circ\text{C}/\text{W}$

¹⁾ Pulse Test: Pulse Width ≤ 100 μs , Duty Cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ\text{C}$.

²⁾ Limited by $T_{J(MAX)}$, starting $T_J = 25^\circ\text{C}$, $L = 0.1$ mH, $R_g = 25$ Ω , $I_{AS} = 12$ A, $V_{GS} = 10$ V.

³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

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Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified (Q1/Q2)

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $-I_D = 250 \mu\text{A}$	$-V_{(BR)DSS}$	30	-	-	V
Drain-Source On-State Current at $-V_{DS} = 24 \text{ V}$	$-I_{DSS}$	-	-	1	μA
Gate-Source Leakage Current at $V_{GS} = \pm 20 \text{ V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $-I_D = 250 \mu\text{A}$	$-V_{GS(th)}$	1	-	2.5	V
Drain-Source On-State Resistance at $-V_{GS} = 10 \text{ V}$, $-I_D = 8 \text{ A}$ at $-V_{GS} = 4.5 \text{ V}$, $-I_D = 6 \text{ A}$	$R_{DS(ON)}$	- -	52 -	60 110	$\text{m}\Omega$
DYNAMIC PARAMETERS					
Gate resistance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	R_g	-	5.8	-	Ω
Forward Transconductance at $-V_{DS} = 5 \text{ V}$, $-I_D = 8 \text{ A}$	g_{fs}	-	8.5	-	S
Input Capacitance at $V_{GS} = 0 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	420	-	pF
Output Capacitance at $V_{GS} = 0 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	53	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	46	-	pF
Total Gate Charge at $-V_{GS} = 10 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $-I_D = 8 \text{ A}$ at $-V_{GS} = 4.5 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $-I_D = 8 \text{ A}$	Q_g	- -	9 4	- -	nC
Gate-Source Charge at $-V_{GS} = 10 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $-I_D = 8 \text{ A}$	Q_{gs}	-	2	-	nC
Gate-Drain Charge at $-V_{GS} = 10 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $-I_D = 8 \text{ A}$	Q_{gd}	-	1	-	nC
Turn-On Delay Time at $-V_{GS} = 10 \text{ V}$, $-V_{DD} = 15 \text{ V}$, $-I_D = 8 \text{ A}$, $R_g = 3.3 \Omega$	$t_{d(on)}$	-	6	-	nS
Turn-On Rise Time at $-V_{GS} = 10 \text{ V}$, $-V_{DD} = 15 \text{ V}$, $-I_D = 8 \text{ A}$, $R_g = 3.3 \Omega$	t_r	-	22	-	nS
Turn-Off Delay Time at $-V_{GS} = 10 \text{ V}$, $-V_{DD} = 15 \text{ V}$, $-I_D = 8 \text{ A}$, $R_g = 3.3 \Omega$	$t_{d(off)}$	-	7	-	nS
Turn-Off Fall Time at $-V_{GS} = 10 \text{ V}$, $-V_{DD} = 15 \text{ V}$, $-I_D = 8 \text{ A}$, $R_g = 3.3 \Omega$	t_f	-	1	-	nS
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $-I_S = 1 \text{ A}$, $V_{GS} = 0 \text{ V}$	$-V_{SD}$	-	-	1.2	V
Body-Diode Continuous Current	$-I_S$	-	-	17	A
Body-Diode Continuous Current, Pulsed	$-I_{SM}$	-	-	40	A
Body Diode Reverse Recovery Time at $-I_S = 8 \text{ A}$, $di/dt = 100 \text{ A} / \mu\text{s}$	t_{rr}	-	7	-	nS
Body Diode Reverse Recovery Charge at $-I_S = 8 \text{ A}$, $di/dt = 100 \text{ A} / \mu\text{s}$	Q_{rr}	-	3	-	nC

Electrical Characteristics Curves (Q1/Q2)

Fig. 1 Typical Output Characteristic

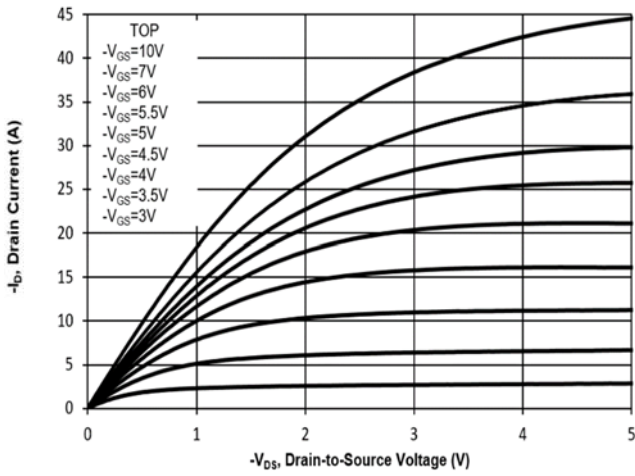


Fig. 2 Typical Transfer Characteristic

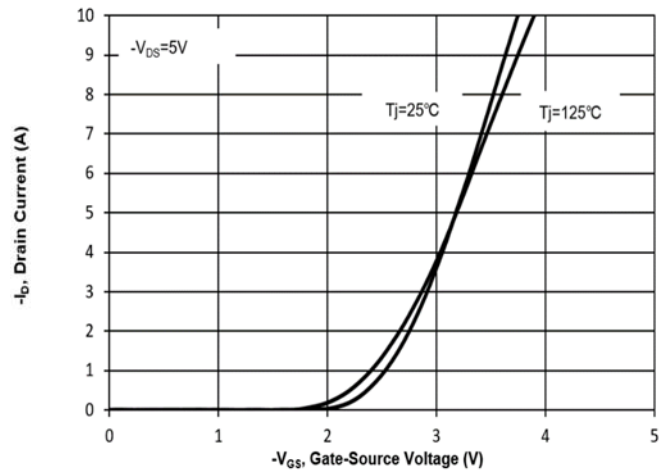


Fig. 3 on-Resistance vs. Drain Current

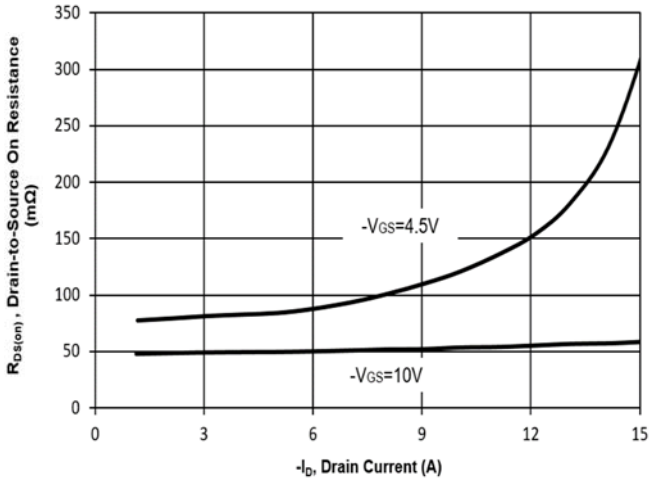


Fig. 4 on-Resistance vs. Gate Voltage

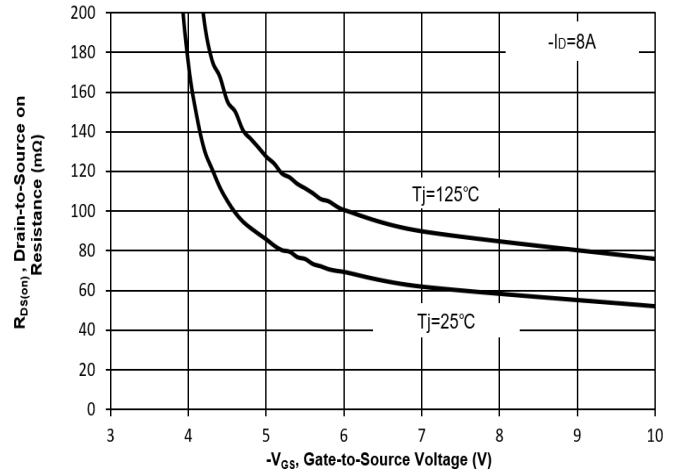


Fig. 5 on-Resistance vs. Tj

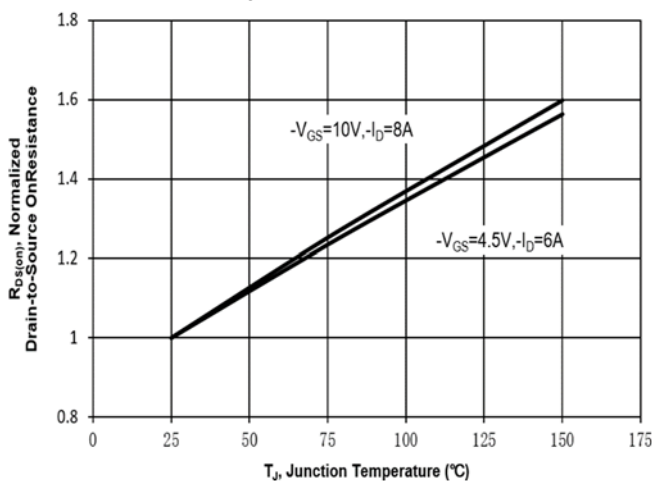
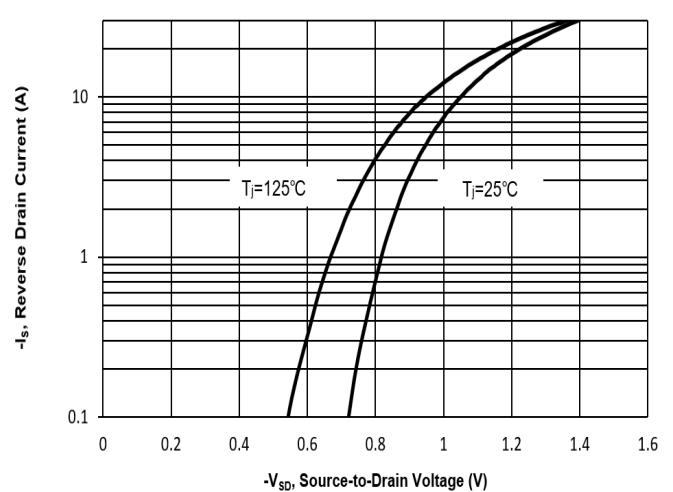


Fig. 6 Typical Body-Diode Forward Characteristic



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Electrical Characteristics Curves (Q1/Q2)

Fig. 7 Typical Junction Capacitance

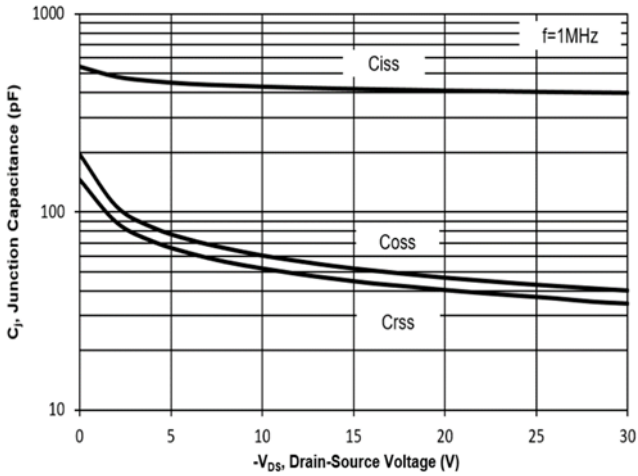


Fig. 8 Drain-Source Leakage Current vs. T_j

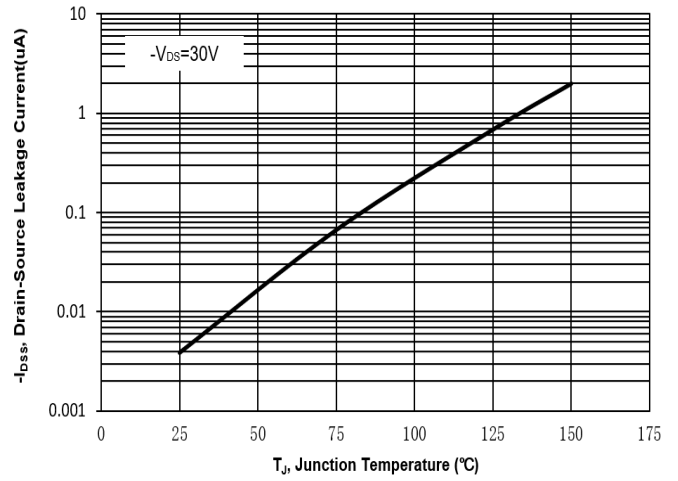


Fig. 9 V_{(BR)DSS} vs. Junction Temperature

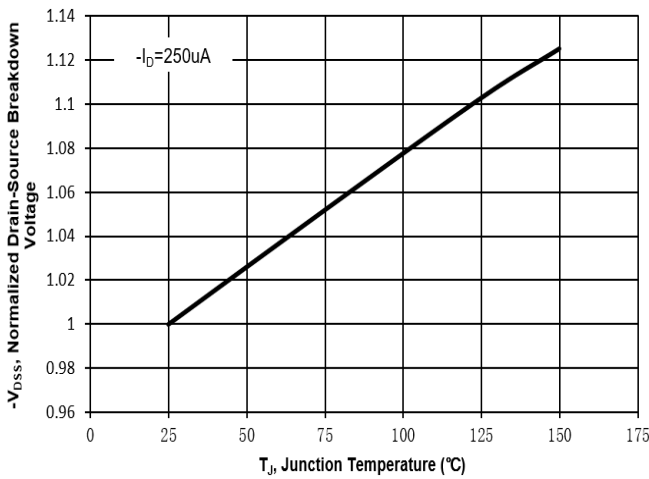


Fig. 10 Gate Threshold Variation vs. T_j

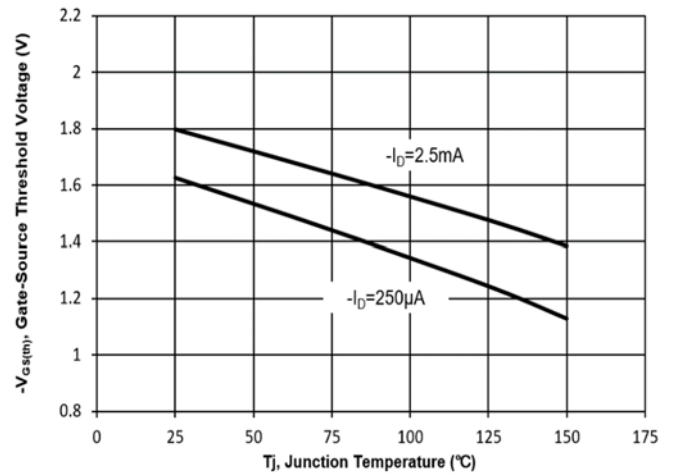


Fig. 11 Gate Charge

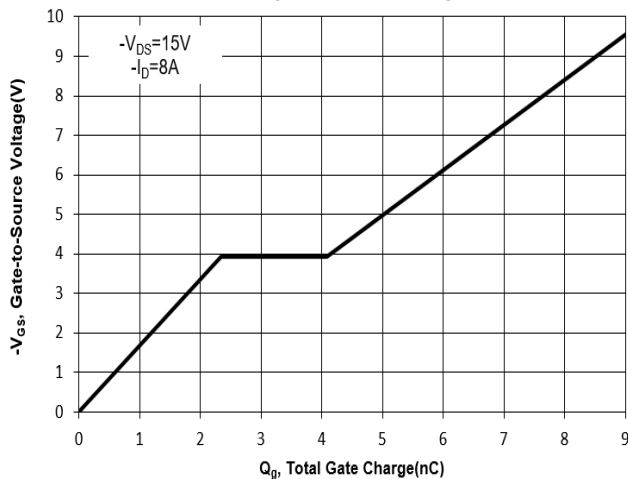
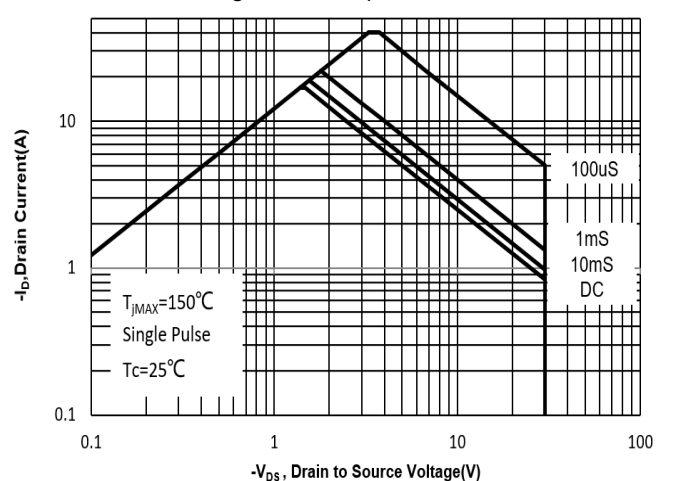


Fig. 12 Safe Operation Area



Electrical Characteristics Curves (Q1/Q2)

Fig. 13 Normalized Maximum Transient Thermal Impedance($Z_{\theta JC}$)

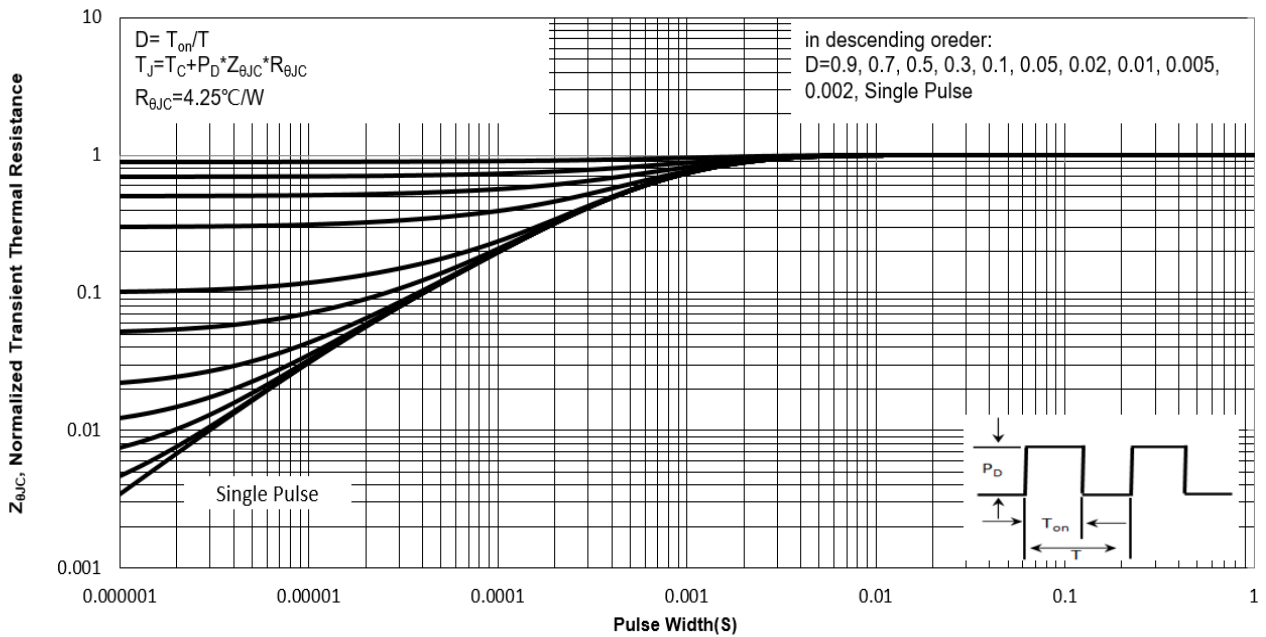
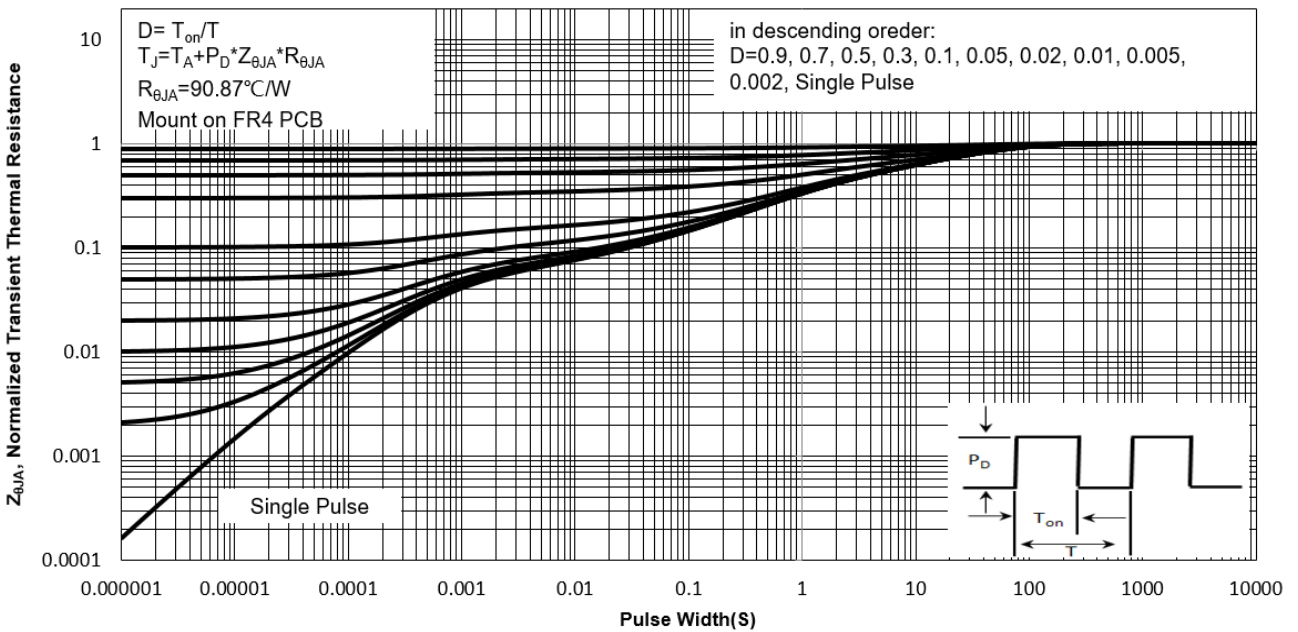


Fig. 14 Normalized Maximum Transient Thermal Impedance($Z_{\theta JA}$)



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Test Circuits (Q1/Q2)

Fig.1-1 Switching times test circuit

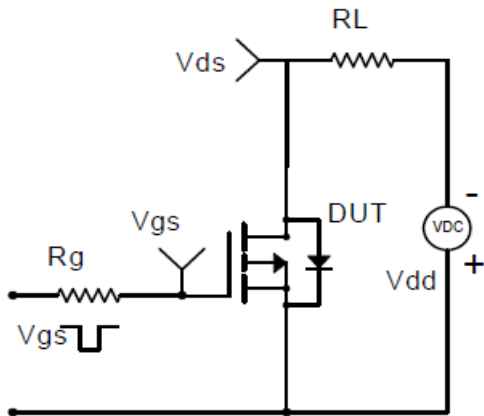


Fig.1-2 Switching Waveform

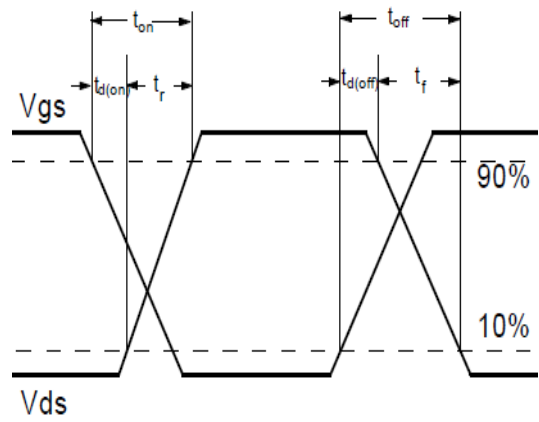


Fig.2-1 Gate charge test circuit

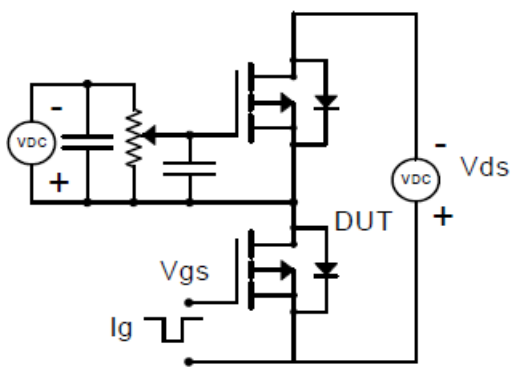


Fig.2-2 Gate charge waveform

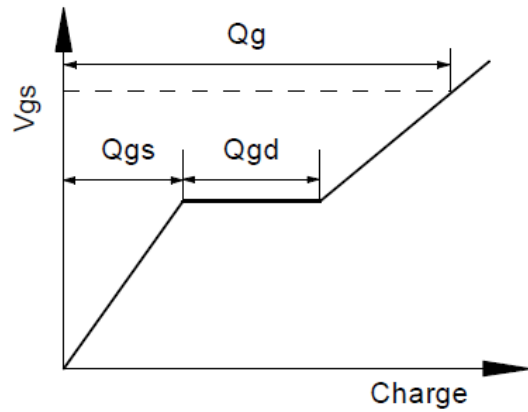


Fig.3-1 Avalanche test circuit

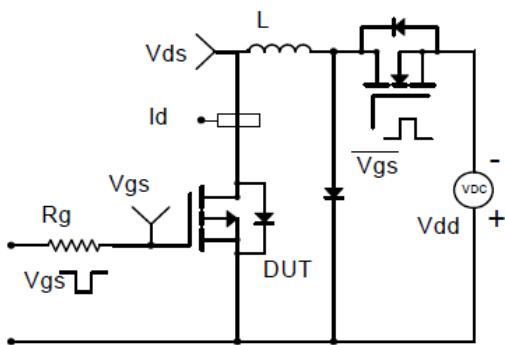
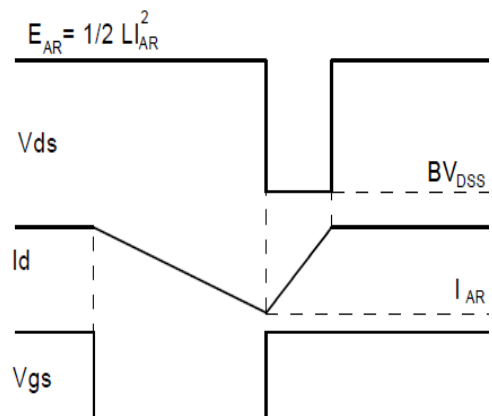


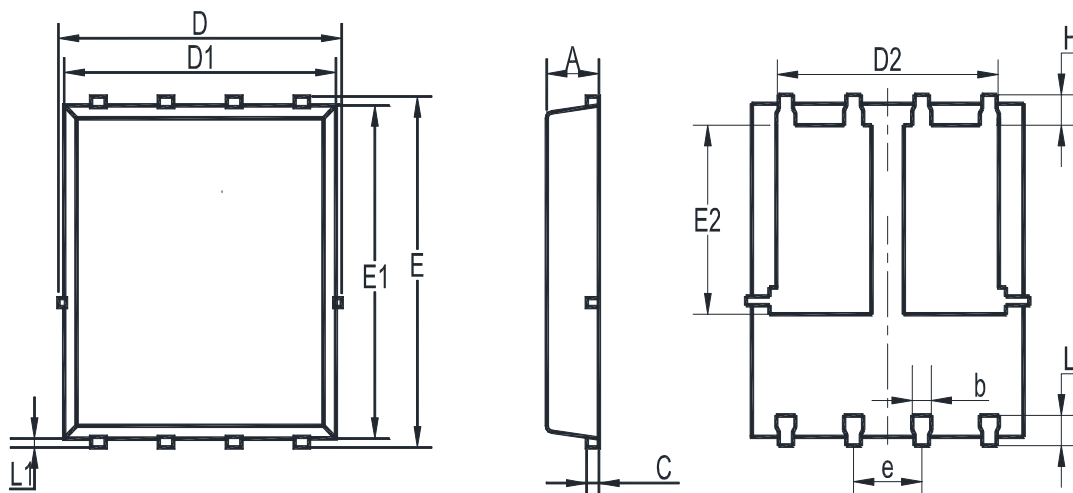
Fig.3-2 Avalanche waveform



WTM603B600LS-HAF

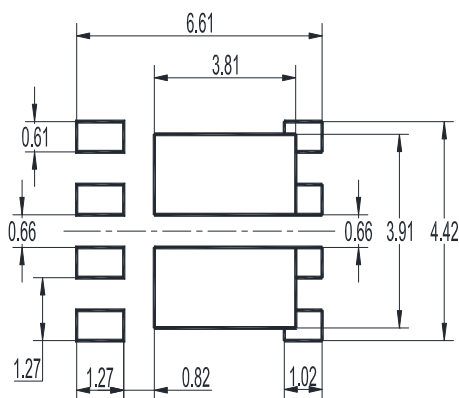
Package Outline Dimensions (Units: mm)

DFN5060



Unit	A	b	C	D	D1	D2	E	E1	E2	e	L	L1	H
mm	1.12	0.51	0.34	5.26	5.1	4.5	6.25	6	3.66	1.37	0.71	0.2	0.71
	0.9	0.33	0.11	4.7	4.7	3.56	5.75	5.6	3.18	1.17	0.35	0.06	0.35

Recommended Soldering Footprint

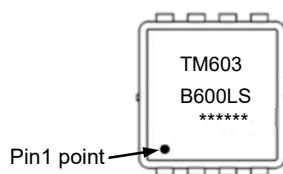


Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
DFN5060	12	8 ± 0.1	0.315 ± 0.004	330	13	3,000

Marking information

- " TM603B600LS " = Part No.
 - " ***** " = Date Code Marking
- Font type: Arial



Winning Team
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